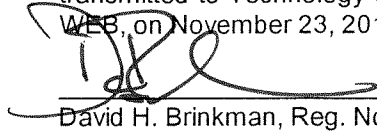


Do not enter  
/TvP/  
11/30/2010

**CERTIFICATE OF ELECTRONIC  
TRANSMISSION**

I hereby certify that this correspondence for  
Application No. 10/555,713 is being electronically  
transmitted to Technology Center 2894, via EFS-  
WEB, on November 23, 2010.

 11/23/10  
David H. Brinkman, Reg. No. 40,532 Date

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants : Martin Hausner et al.  
Serial No. : 10/555,713  
Filed : October 20, 2006  
Confirmation No. : 9725  
Group Art Unit : 2894  
Examiner : Pham, Thanh V.  
Title : **RADIATION SENSOR, WAFER, SENSOR MODULE AND  
METHOD FOR MANUFACTURING A RADIATION SENSOR**  
Attorney Docket No. : BEET-14

Cincinnati, Ohio 45202

November 23, 2010

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**AFTER FINAL AMENDMENT**

In response to the Office Action mailed on July 23, 2010, please amend  
the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page  
2 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.